

AMPMODU | AMPMODU Headers

TE Internal #: 969587-2

PCB Mount Header, Vertical, Board-to-Board, 10 Position, 2.5 mm [. 098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder,

AMPMODU Headers

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Connectors > PCB Connectors > PCB Headers & Receptacles



PCB Connector Assembly Type: PCB Mount Header

PCB Mount Orientation: Vertical
Connector System: Board-to-Board

Number of Positions: 10

Number of Rows: 2

Features

Product Type Features

PCB Connector Assembly Type	PCB Mount Header
Connector System	Board-to-Board
Header Type	Fully Shrouded
Sealable	No
Connector & Contact Terminates To	Printed Circuit Board

Configuration Features

Connector Contact Load Condition	Fully Loaded
PCB Mount Orientation	Vertical
Number of Positions	10
Number of Rows	2
Board-to-Board Configuration	Parallel

Body Features

Connector Profile	Standard
Primary Product Color	Black

Contact Features

Mating Square Post Dimension	.63 mm[.025 in]
Contact Shape & Form	Square
Contact Underplating Material	Nickel



PCB Contact Termination Area Plating Material	Tin
Contact Base Material	Copper Tin Alloy
Contact Mating Area Plating Material	Tin
Contact Mating Area Plating Material Thickness	.0254 μm[1 μin]
Contact Type	Pin
Contact Current Rating (Max)	3 A
Termination Features	
Square Termination Post & Tail Dimension	.63 mm[.025 in]
Termination Post & Tail Length	3.4 mm[.134 in]
Termination Method to Printed Circuit Board	Through Hole - Solder
Mechanical Attachment	
Mating Alignment	With
Mating Alignment Type	Polarization
PCB Mount Retention	Without
PCB Mount Alignment	Without
Connector Mounting Type	Board Mount
Housing Features	
Housing Features Centerline (Pitch)	2.5 mm[.098 in]
	2.5 mm[.098 in] PBT GF
Centerline (Pitch)	
Centerline (Pitch) Housing Material	
Centerline (Pitch) Housing Material Dimensions	PBT GF
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing	PBT GF 2.54 mm[.1 in]
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing PCB Thickness (Recommended)	PBT GF 2.54 mm[.1 in]
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions	PBT GF 2.54 mm[.1 in] 1.57 mm[.062 in]
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Operating Temperature Range	PBT GF 2.54 mm[.1 in] 1.57 mm[.062 in]
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Operating Temperature Range Operation/Application	PBT GF 2.54 mm[.1 in] 1.57 mm[.062 in] -65 – 105 °C[-85 – 221 °F]
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Operating Temperature Range Operation/Application Circuit Application	PBT GF 2.54 mm[.1 in] 1.57 mm[.062 in] -65 – 105 °C[-85 – 221 °F]
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Operating Temperature Range Operation/Application Circuit Application Industry Standards	PBT GF 2.54 mm[.1 in] 1.57 mm[.062 in] -65 – 105 °C[-85 – 221 °F] Signal
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Operating Temperature Range Operation/Application Circuit Application Industry Standards UL Flammability Rating	PBT GF 2.54 mm[.1 in] 1.57 mm[.062 in] -65 – 105 °C[-85 – 221 °F] Signal
Centerline (Pitch) Housing Material Dimensions Row-to-Row Spacing PCB Thickness (Recommended) Usage Conditions Operating Temperature Range Operation/Application Circuit Application Industry Standards UL Flammability Rating Packaging Features	PBT GF 2.54 mm[.1 in] 1.57 mm[.062 in] -65 – 105 °C[-85 – 221 °F] Signal UL 94V-0



Product Compliance

For compliance documentation, visit the product page on TE.com>

EU RoHS Directive 2011/65/EU	Compliant
EU ELV Directive 2000/53/EC	Compliant
China RoHS 2 Directive MIIT Order No 32, 2016	No Restricted Materials Above Threshold
EU REACH Regulation (EC) No. 1907/2006	Current ECHA Candidate List: JUNE 2023 (235) Candidate List Declared Against: JAN 2023 (233) Does not contain REACH SVHC
Halogen Content	Low Halogen - Br, Cl, F, I < 900 ppm per homogenous material. Also BFR/CFR/PVC Free
Solder Process Capability	Wave solder capable to 240°C

Product Compliance Disclaimer

This information is provided based on reasonable inquiry of our suppliers and represents our current actual knowledge based on the information they provided. This information is subject to change. The part numbers that TE has identified as EU RoHS compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, mercury, PBB, PBDE, DBP, BBP, DEHP, DIBP, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2011/65/EU (RoHS2). Finished electrical and electronic equipment products will be CE marked as required by Directive 2011/65/EU. Components may not be CE marked. Additionally, the part numbers that TE has identified as EU ELV compliant have a maximum concentration of 0.1% by weight in homogenous materials for lead, hexavalent chromium, and mercury, and 0.01% for cadmium, or qualify for an exemption to these limits as defined in the Annexes of Directive 2000/53/EC (ELV). Regarding the REACH Regulation, the information TE provides on SVHC in articles for this part number is based on the latest European Chemicals Agency (ECHA) 'Guidance on requirements for substances in articles' posted at this URL: https://echa.europa.eu/guidance-documents/guidance-on-reach

Compatible Parts







Also in the Series | AMPMODU Headers





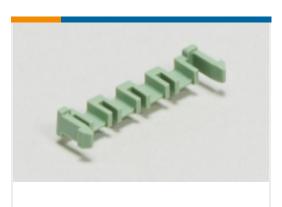
PCB Connector Mounting(1)



PCB Connector Shrouds(1)



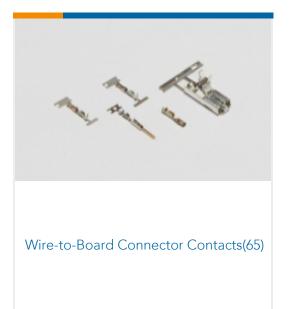
PCB Headers & Receptacles(4961)



PCB Latches, Locks & Retainers(2)



Wire-to-Board Connector Assemblies & Housings(5)



Customers Also Bought



DYNAMIC D3100D TAB HSG PM 10P





















Documents

PCB Mount Header, Vertical, Board-to-Board, 10 Position, 2.5 mm [.098 in] Centerline, Fully Shrouded, Tin, Through Hole - Solder, AMPMODU Headers



Product Drawings

MOD2 STIFTLEIS2X5P

English

CAD Files

3D PDF

English

Customer View Model

ENG_CVM_969587-2_B1.2d_dxf.zip

English

Customer View Model

ENG_CVM_969587-2_B1.3d_igs.zip

English

Customer View Model

ENG_CVM_969587-2_B1.3d_stp.zip

English

By downloading the CAD file I accept and agree to the **Terms and Conditions** of use.

Datasheets & Catalog Pages

AMPMODU Interconnetion System

AMPMODU Interconnetion System

English